

# **Test Report**

日期(Date): 2015/09/15

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鈞寶電子工業股份有限公司 KING CORE ELECTRONICS INC.

桃園市平鎮區南豐路269號(平鎮工業區)

NO. 269, NANFONG RD., PINGJHEN DISTRICT, TAOYUAN CITY 324, TAIWAN

號碼(No.): CE/2015/92588

以下測試樣品係由申請廠商所提供及確認 (The following sample(s) was/were submitted and identified by/on behalf of the applicant as):

送樣廠商(Sample Submitted By) 鈞寶電子工業股份有限公司 (KING CORE ELECTRONICS INC.)

樣品名稱(Sample Description) SMD WOUND CHIP INDUCTORS

FLCXXXXNLCL SERIES 樣品型號(Style/Item No.)

收件日期(Sample Receiving Date) 2015/09/10

2015/09/10 TO 2015/09/15 測試期間(Testing Period)

測試需求(Test Requested):

(1) 依據客戶指定,參考RoHS2011/65/EU Annex II及其修訂指令(EU) 2015/863測試編、鉛、汞、六價鉻、多溴聯苯、多溴聯苯 醚, DBP, BBP, DEHP, DIBP. (As specified by client, with reference to RoHS 2011/65/EU Annex II and amending Directive (EU) 2015/863 to determine Cadmium, Lead, Mercury, Cr(VI), PBBs, PBDEs, DBP, BBP, DEHP, DIBP contents in the submitted sample.)

(2) 其他測試項目請見下一頁 . (Please refer to next pages for the other item(s).)

請見下一頁 (Please refer to next pages). 測試結果(Test Results) :

結論(Conclusion) :

(1) 根據客戶所提供的樣品,其鎬、鉛、汞、六價鉻、多溴聯苯、多溴聯苯醚, DBP, BBP, DEHP, DIBP 的測試結果符合RoHS指令暨(EU) 2015/863之限值要求. (Based on the performed tests on submitted samples, the test results of Cadmium, Lead, Mercury, Cr(VI), PBBs, PBDEs, DBP, BBP, DEHP, DIBP comply with the limits as set by RoHS and amending Directive (EU) 2015/863.)

Troy Chang Manager Signed for and on beha SGS TAIWAN LTD. Chemical Laboratory - Taipei

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號碼(No.): CE/2015/92588

### 測試結果(Test Results)

測試部位(PART NAME)No.1 : SMD WOUND CHIP INDUCTORS

測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限值 (MDL)	結果 (Result) No.1	限值 (Limit)
鎬 / Cadmium (Cd)	mg/kg	參考IEC 62321-5: 2013方法, 以感應 耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321-5: 2013 and performed by ICP-AES.	2	n. d.	100
鉛 / Lead (Pb)	mg/kg	參考IEC 62321-5: 2013方法, 以感應 耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321-5: 2013 and performed by ICP-AES.	2	n. d.	1000
汞 / Mercury (Hg)	mg/kg	參考IEC 62321-4: 2013方法, 以感應 耦合電漿原子發射光譜儀檢測. / With reference to IEC 62321-4: 2013 and performed by ICP-AES.	2	n. d.	1000
六價鉻 / Hexavalent Chromium Cr(VI)	mg/kg	參考IEC 62321: 2008方法,以UV-VIS 檢測. / With reference to IEC 62321: 2008 and performed by UV- VIS.	2	n. d.	1000
砷 / Arsenic (As)	mg/kg	參考US EPA 3052方法,以感應耦合電 漿原子發射光譜儀檢測. / With reference to US EPA Method 3052. Analysis was performed by ICP-AES.	2	n. d.	-
六溴環十二烷及所有主要被辨別出的異構物 / Hexabromocyclododecane (HBCDD) and all major diastereoisomers identified ( $\alpha$ – HBCDD, $\beta$ – HBCDD, $\gamma$ – HBCDD) (CAS No.: 25637–99–4 and 3194–55–6 (134237–51–7, 134237–50–6, 134237–52–8))	mg/kg	参考IEC 62321: 2008方法,以氣相層析/質譜儀檢測. / With reference to IEC 62321: 2008 method. Analysis was performed by GC/MS.	5	n. d.	-

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號碼(No.): CE/2015/92588

結果 方法偵測 測試項目 單位 測試方法 限值 (Result) 極限值 (Limit) (Test Items) (Unit) (Method) (MDL) No. 1 全氟辛烷磺酸 / Perfluorooctane 参考US EPA 3550C: 2007方法, 以液相 mg/kg 10 n. d. 層析/質譜儀檢測. / With reference sulfonates (PFOS-Acid, Metal Salt, Amide) to US EPA 3550C: 2007. Analysis was performed by LC/MS. 全氟辛酸 / PFOA (CAS No.: 335-67-1) 參考US EPA 3550C: 2007方法, 以液相 10 mg/kg n. d. 層析/質譜儀檢測. / With reference to US EPA 3550C: 2007. Analysis was performed by LC/MS. 參考IEC 62321-8 (111/321/CD),以氣 鄰苯二甲酸丁苯甲酯 / BBP (Butvl 50 1000 mg/kg n. d. Benzyl phthalate) (CAS No.: 85-68-7) 相層析儀/質譜儀檢測之. / With reference to IEC 62321-8 (111/321/CD). Analysis was performed by GC/MS. 參考IEC 62321-8 (111/321/CD),以氣 鄰苯二甲酸二丁酯 / DBP (Dibutyl 1000 50 n. d. mg/kg phthalate) (CAS No.: 84-74-2) 相層析儀/質譜儀檢測之. / With reference to IEC 62321-8 (111/321/CD). Analysis was performed by GC/MS. 參考IEC 62321-8 (111/321/CD),以氣 1000 鄰苯二甲酸二異丁酯 / DIBP (Dimg/kg 50 n. d. isobutyl phthalate) (CAS No.: 84-69-相層析儀/質譜儀檢測之. / With reference to IEC 62321-8 5) (111/321/CD). Analysis was performed by GC/MS. 鄰苯二甲酸二 (2-乙基己基)酯 / DEHP 參考IEC 62321-8 (111/321/CD),以氣 50 1000 mg/kg n. d. (Di- (2-ethylhexyl) phthalate) (CAS 相層析儀/質譜儀檢測之. / With No.: 117-81-7) reference to IEC 62321-8 (111/321/CD). Analysis was performed by GC/MS.

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號碼(No.): CE/2015/92588

測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1	限値 (Limit)
多溴聯苯總和 / Sum of PBBs	mg/kg		-	n. d.	1000
一溴聯苯 / Monobromobiphenyl	mg/kg		5	n. d.	-
二溴聯苯 / Dibromobiphenyl	mg/kg		5	n. d.	-
三溴聯苯 / Tribromobiphenyl	mg/kg		5	n. d.	-
四溴聯苯 / Tetrabromobiphenyl	mg/kg		5	n. d.	-
五溴聯苯 / Pentabromobiphenyl	mg/kg		5	n. d.	-
六溴聯苯 / Hexabromobiphenyl	mg/kg	参考IEC 62321-6: 2015方法,以氣相 層析/質譜儀檢測. / With reference to IEC 62321-6: 2015 and performed by GC/MS.	5	n. d.	-
七溴聯苯 / Heptabromobiphenyl	mg/kg		5	n. d.	-
八溴聯苯 / Octabromobiphenyl	mg/kg		5	n. d.	_
九溴聯苯 / Nonabromobiphenyl	mg/kg		5	n. d.	_
十溴聯苯 / Decabromobiphenyl	mg/kg		5	n. d.	-
多溴聯苯醚總和 / Sum of PBDEs	mg/kg		-	n. d.	1000
一溴聯苯醚 / Monobromodiphenyl ether	mg/kg		5	n. d.	-
二溴聯苯醚 / Dibromodiphenyl ether	mg/kg		5	n. d.	-
三溴聯苯醚 / Tribromodiphenyl ether	mg/kg		5	n. d.	-
四溴聯苯醚 / Tetrabromodiphenyl ether	mg/kg		5	n. d.	-
五溴聯苯醚 / Pentabromodiphenyl ether	mg/kg		5	n. d.	-
六溴聯苯醚 / Hexabromodiphenyl ether	mg/kg		5	n. d.	-
七溴聯苯醚 / Heptabromodiphenyl ether	mg/kg		5	n. d.	_
八溴聯苯醚 / Octabromodiphenyl ether	mg/kg		5	n. d.	_
九溴聯苯醚 / Nonabromodiphenyl ether	mg/kg		5	n. d.	_
十溴聯苯醚 / Decabromodiphenyl ether	mg/kg		5	n. d.	_

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NO. 269, NANFONG RD., PINGJHEN DISTRICT, TAOYUAN CITY 324, TAIWAN

測試項目 (Test Items)	單位 (Unit)	測試方法 (Method)	方法偵測 極限値 (MDL)	結果 (Result) No.1	限值 (Limit)
鹵素 / Halogen					
鹵素(氟)/ Halogen-Fluorine (F) (CAS No.: 14762-94-8)	mg/kg		50	n. d.	-
鹵素(氯)/ Halogen-Chlorine (C1) (CAS No.: 22537-15-1)	mg/kg	参考BS EN 14582:2007,以離子層析儀 分析. / With reference to BS EN 14582:2007. Analysis was performed by IC.	50	n. d.	-
鹵素(溴)/ Halogen-Bromine (Br) (CAS No.: 10097-32-2)	mg/kg		50	n. d.	-
鹵素(碘)/ Halogen-Iodine(I)(CAS No.: 14362-44-8)	mg/kg		50	n. d.	-

#### 備註(Note):

- 1. mg/kg = ppm; 0. 1wt% = 1000ppm
- 2. n.d. = Not Detected (未檢出)
- 3. MDL = Method Detection Limit (方法偵測極限值)
- 4. "-" = Not Regulated (無規格值)

#### PFOS参考資訊(Reference Information): 持久性有機污染物 POPs - (EU) 757/2010

PFOS濃度在物質或製備中不得超過0.001%(10ppm),在半成品、成品或零部件中不得超過0.1%(1000ppm),在紡織品或塗 層材料中不得超過lug/m<sup>2</sup>。

(Outlawing PFOS as substances or preparations in concentrations above 0.001% (10ppm), in semi-finished products or articles or parts at a level above 0.1%(1000ppm), in textiles or other coated materials above  $1\mu g/m^2$ .)



# **Test Report**

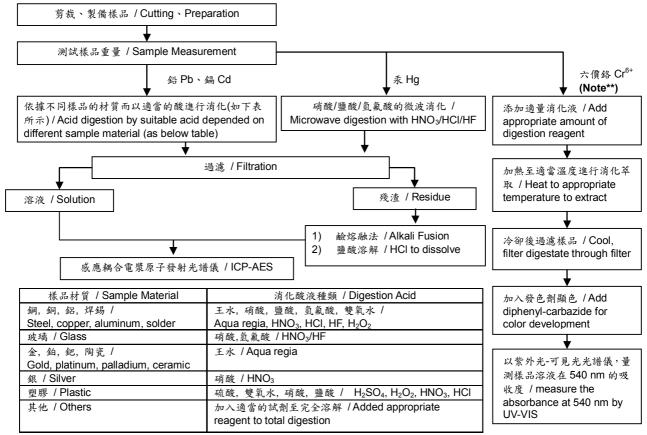
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鈞寶電子工業股份有限公司 KING CORE ELECTRONICS INC.

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NO. 269, NANFONG RD., PINGJHEN DISTRICT, TAOYUAN CITY 324, TAIWAN

- 根據以下的流程圖之條件,樣品已完全溶解。( 六價鉻測試方法除外) / These samples were dissolved totally by pre-conditioning method according to below flow chart. (  $\text{Cr}^{6^+}$  test method excluded )
- 測試人員:楊登偉 / Name of the person who made measurement: Climbgreat Yang
- 測試負責人: 張啟興 / Name of the person in charge of measurement: Troy Chang



#### Note\*\* (For IEC 62321)

- (1) 針對非金屬材料加入鹼性消化液,加熱至 90~95℃萃取. / For non-metallic material, add alkaline digestion reagent and heat to 90~95℃
- (2) 針對金屬材料加入純水,加熱至沸騰萃取. / For metallic material, add pure water and heat to boiling.

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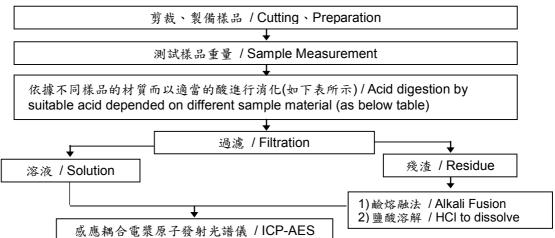


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- 根據以下的流程圖之條件,樣品已完全溶解。 / These samples were dissolved totally by pre-conditioning method according to below flow chart.
- 測試人員:楊登偉 / Name of the person who made measurement: Climbgreat Yang
- 測試負責人:張啟興 / Name of the person in charge of measurement: Troy Chang

### 元素以 ICP-AES 分析的消化流程圖 (Flow Chart of digestion for the elements analysis performed by ICP-AES)

日期(Date): 2015/09/15



鋼,銅,鋁,焊錫 / Steel, copper, aluminum, solder	王水,硝酸,鹽酸,氫氟酸,雙氧水 /
	Aqua regia, HNO <sub>3</sub> , HCl, HF, H <sub>2</sub> O <sub>2</sub>
玻璃 / Glass	硝酸,氫氟酸 / HNO <sub>3</sub> /HF
金,鉑,鈀,陶瓷 / Gold, platinum, palladium, ceramic	王水 / Aqua regia
銀 / Silver	硝酸 / HNO <sub>3</sub>
塑膠 / Plastic	硫酸,雙氧水,硝酸,鹽酸 / H <sub>2</sub> SO <sub>4</sub> , H <sub>2</sub> O <sub>2</sub> , HNO <sub>3</sub> , HCI
其他 / Others	加入適當的試劑至完全溶解 / Added appropriate reagent to total digestion



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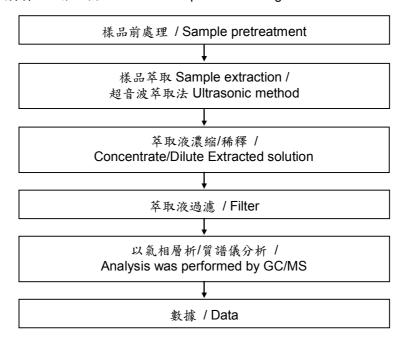


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#### 六溴環十二烷分析流程圖 / HBCDD analytical flow chart

日期(Date): 2015/09/15

- 測試人員: 翁賜彬 / Name of the person who made measurement: Roman Wong
- 測試負責人: 張啟興 / Name of the person in charge of measurement: Troy Chang





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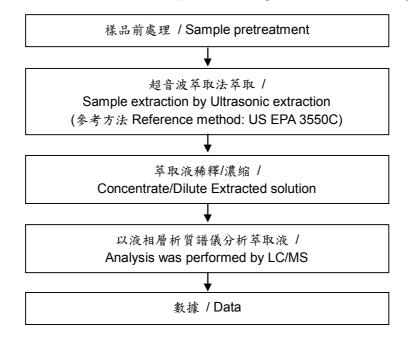


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### 全氟辛酸/全氟辛烷磺酸分析流程圖 / PFOA/PFOS analytical flow chart

日期(Date): 2015/09/15

- 測試人員: 翁賜彬 / Name of the person who made measurement: Roman Wong
- 測試負責人:張啟興 / Name of the person in charge of measurement: Troy Chang





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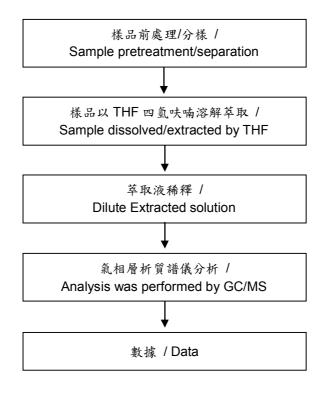
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### 可塑劑分析流程圖 / Analytical flow chart of phthalate content

日期(Date): 2015/09/15

- 測試人員:徐毓明 / Name of the person who made measurement: Andy Shu
- 測試負責人: 張啟興 / Name of the person in charge of measurement: Troy Chang

#### 【測試方法/Test method: IEC 62321-8】





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#### 多溴聯苯/多溴聯苯醚分析流程圖 / PBB/PBDE analytical FLOW CHART

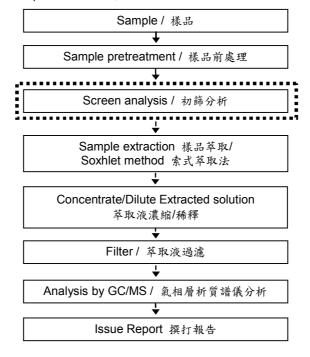
日期(Date): 2015/09/15

- 測試人員: 翁賜彬 / Name of the person who made measurement: Roman Wong
- 測試負責人: 張啟興 / Name of the person in charge of measurement: Troy Chang

初次測試程序 / First testing process -選擇性篩檢程序 / Optional screen process • • •

確認程序 / Confirmation process - · - · ▶

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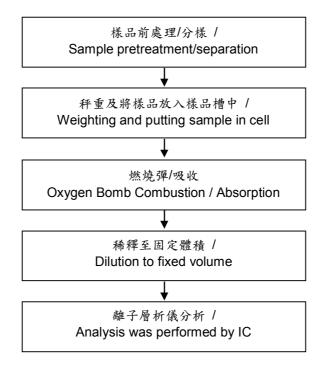


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### 鹵素分析流程圖 / Analytical flow chart of halogen content

日期(Date): 2015/09/15

- 測試人員: 陳恩臻 / Name of the person who made measurement: Rita Chen
- 測試負責人: 張啟興 / Name of the person in charge of measurement: Troy Chang



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Member of the SGS Group



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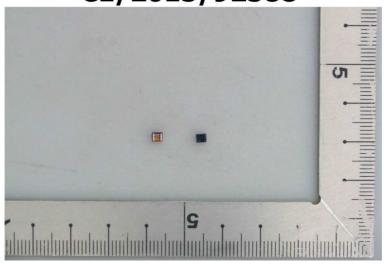
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\* 照片中如有箭頭標示,則表示為實際檢測之樣品/部位. \* (The tested sample / part is marked by an arrow if it's shown on the photo.)

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\*\* 報告結尾 (End of Report) \*\*